

Polar[™] HiperFET[™] Power MOSFET

IXFH170N10P IXFK170N10P

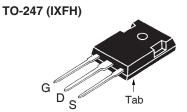
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier



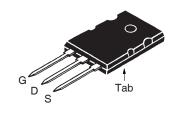
Symbol	Test Conditions	Maximum	Ratings
V _{DSS}	$T_J = 25^{\circ}C$ to 175°C	100	V
$\mathbf{V}_{\mathtt{DGR}}$	$T_{_{\rm J}} = 25^{\circ}\text{C}$ to 175°C, $R_{_{\rm GS}} = 1\text{M}\Omega$	100	V
V _{GSS}	Continuous	± 20	V
V _{GSM}	Transient	± 30	V
I _{D25}	T _C = 25°C	170	A
I _{L(RMS)}	External Lead Current Limit	160	А
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	350	Α
I _A	T _C = 25°C	60	A
E _{as}	$T_{c} = 25^{\circ}C$	2	J
dv/dt	$I_{S} \le I_{DM}, V_{DD} \le V_{DSS}, T_{J} \le 175^{\circ}C$	10	V/ns
$\overline{P_D}$	T _C = 25°C	715	W
$T_{\rm J}$		-55 to +175	°C
T_{JM}		+175	°C
T _{stg}		-55 to +175	°C
T _L	1.6mm (0.063in) from Case for 10s	300	°C
T _{SOLD}	Plastic Body for 10s	260	°C
M _d	Mounting Torque	1.13/10	Nm/lb.in.
Weight	TO-247	6	g
	TO-264	10	g

Symbol (T _J = 25°C, U	Test Conditions Unless Otherwise Specified)	Charac Min.	Characteristic Values Min. Typ. Max.		
BV _{DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	100			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 4mA$	2.5		5.0	V
GSS	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$			25	μΑ
	$T_{J} = 150^{\circ}C$			500	μΑ
R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$ $V_{GS} = 15V, I_{D} = 350A$		7	9	mΩ

 $V_{DSS} = 100V \\ I_{D25} = 170A \\ R_{DS(on)} \le 9m\Omega \\ t_{rr} \le 150ns$



TO-264 (IXFK)



G = Gate D = DrainS = Source Tab = Drain

Features

- International Standard Packages
- Fast Intrinsic Rectifier
- Avalanche Rated
- ullet Low $R_{DS(ON)}$ and Q_G
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls



Symbol (T = 25°C	Test Conditions Unless Otherwise Specified)	Charac Min.	cteristic \ Typ.	Values ⊢ Max.
g _{fs}	$V_{DS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$	50	72	S
C _{iss}			6000	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		2340	pF
C _{rss}			730	pF
t _{d(on)}	Decision Control in a Time o		35	ns
t,	Resistive Switching Times		50	ns
t _{d(off)}	$V_{gs} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 60A$		90	ns
t, J	$R_{_{G}} = 3.3\Omega \text{ (External)}$		33	ns
Q _{g(on)}			198	nC
Q _{gs}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		39	nC
\mathbf{Q}_{gd}			107	nC
R _{thJC}				0.21 °C/W
\mathbf{R}_{thCS}	(TO-247)		0.21	°C/W
	(TO-264)		0.15	°C/W

Source-Drain Diode

Symbol	Test Conditions	Charac	cteristic	Values	
$(T_J = 25^{\circ}C)$, Unless Otherwise Specified)	Min.	Тур.	Max.	
I _s	$V_{GS} = 0V$			170	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			350	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.5	V
t _{rr} I _{RM} Q _{RM}	$\begin{cases} I_{F} = 25A, -di/dt = 100A/\mu s, \\ V_{R} = 50V, V_{GS} = 0V \end{cases}$		8.0 0.6	150	ns A µC

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

TO-247 (IXFH) Outline Q S ---e Terminals: 1 - Gate 2 - Drain 3 - Source Tab - Drain Dim. Millimeter Min. Max. Min. Max. 4.7 5.3 .209 .185 2.2 .087 A, 2.54 .102 A₂ 2.2 2.6 .059 .098 b 1.0 1.4 .040 .055 2.13 .065 .084 b₁ 1.65 b, 2.87 3.12 .113 .123 С .8 .016 .031 D 20.80 21.46 .819 .845

.610

0.205

.780

.140

0.232

.170

.640

0.225

.800

.177

.144

0.252

.216

15.75

5.20

19.81

3.55

5.89

4.32

е

L

L1

ØP

Q

R

16.26

5.72

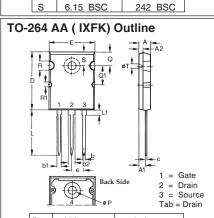
4.50

3.65

6.40

5.49

20.32



Min. Max. Min. Max. A 4.82 5.13 .190 .202 A1 2.54 2.89 .100 .114 A2 2.00 2.10 .079 .083 b 1.12 1.42 .044 .056 b1 2.39 2.69 .094 .106 b2 2.90 3.09 .114 .122
A1 2.54 2.89 .100 .114 A2 2.00 2.10 .079 .083 b 1.12 1.42 .044 .056 b1 2.39 2.69 .094 .106 b2 2.90 3.09 .114 .122
A2 2.00 2.10 .079 .083 b 1.12 1.42 .044 .056 b1 2.39 2.69 .094 .106 b2 2.90 3.09 .114 .122
b 1.12 1.42 .044 .056 b1 2.39 2.69 .094 .106 b2 2.90 3.09 .114 .122
b1 2.39 2.69 .094 .106 b2 2.90 3.09 .114 .122
b2 2.90 3.09 .114 .122
- 0.50 0.00 0.04 0.00
c 0.53 0.83 .021 .033
D 25.91 26.16 1.020 1.030
E 19.81 19.96 .780 .786
e 5.46 BSC .215 BSC
J 0.00 0.25 .000 .010
K 0.00 0.25 .000 .010
L 20.32 20.83 .800 .820
L1 2.29 2.59 .090 .102
P 3.17 3.66 .125 .144
Q 6.07 6.27 .239 .247
Q1 8.38 8.69 .330 .342
R 3.81 4.32 .150 .170
R1 1.78 2.29 .070 .090
S 6.04 6.30 .238 .248
T 1.57 1.83 .062 .072

Fig. 1. Output Characteristics @ T_J = 25°C

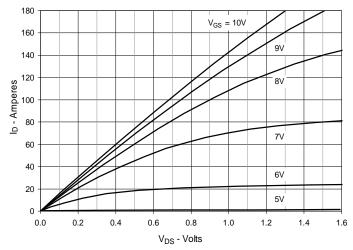


Fig. 2. Extended Output Characteristics @ T_J = 25°C

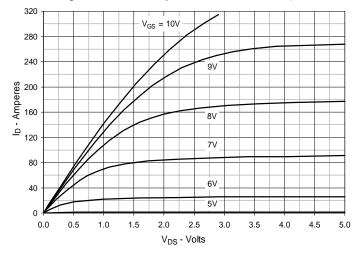


Fig. 3. Output Characteristics @ T_J = 150°C

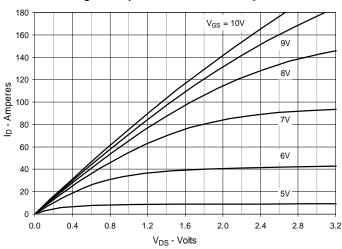


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 85A Value vs. Junction Temperature

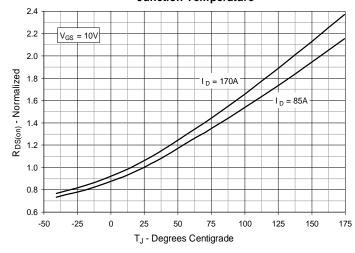


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 85A Value vs.

Drain Current

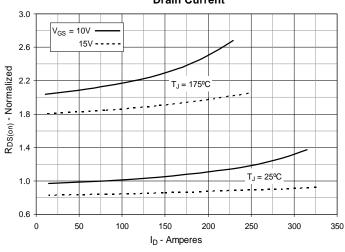
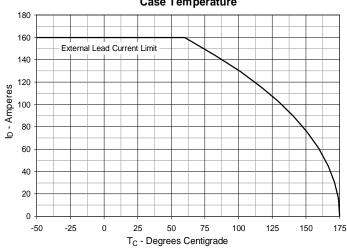
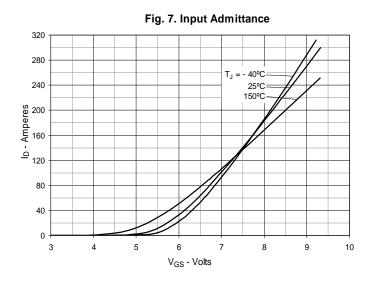


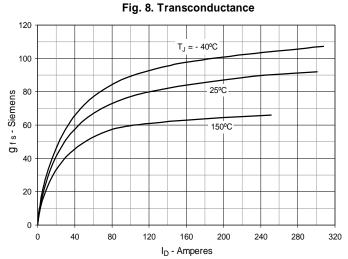
Fig. 6. Maximum Drain Current vs.

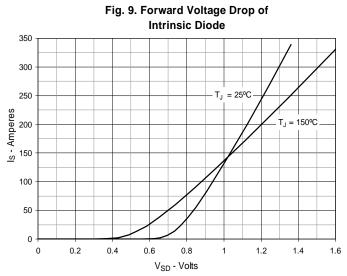
Case Temperature

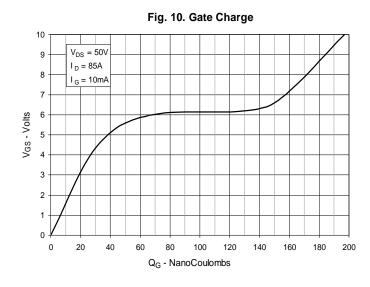


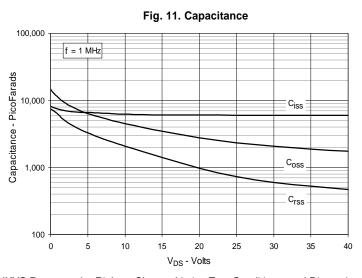


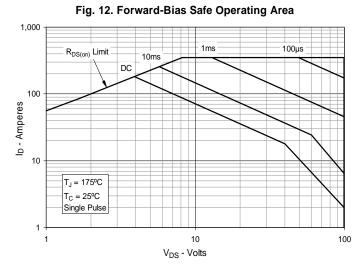












 $\ensuremath{\mathsf{IXYS}}$ Reserves the Right to Change Limits, Test Conditions, and Dimensions.



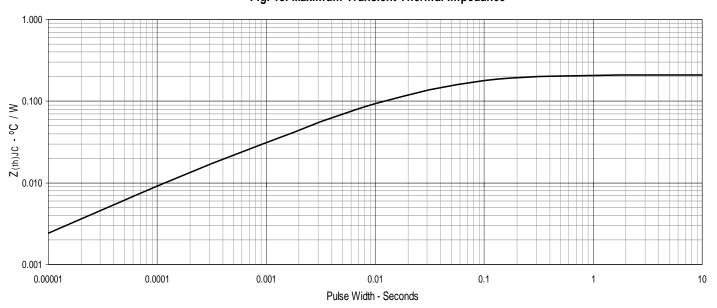


Fig. 13. Maximum Transient Thermal Impedance

